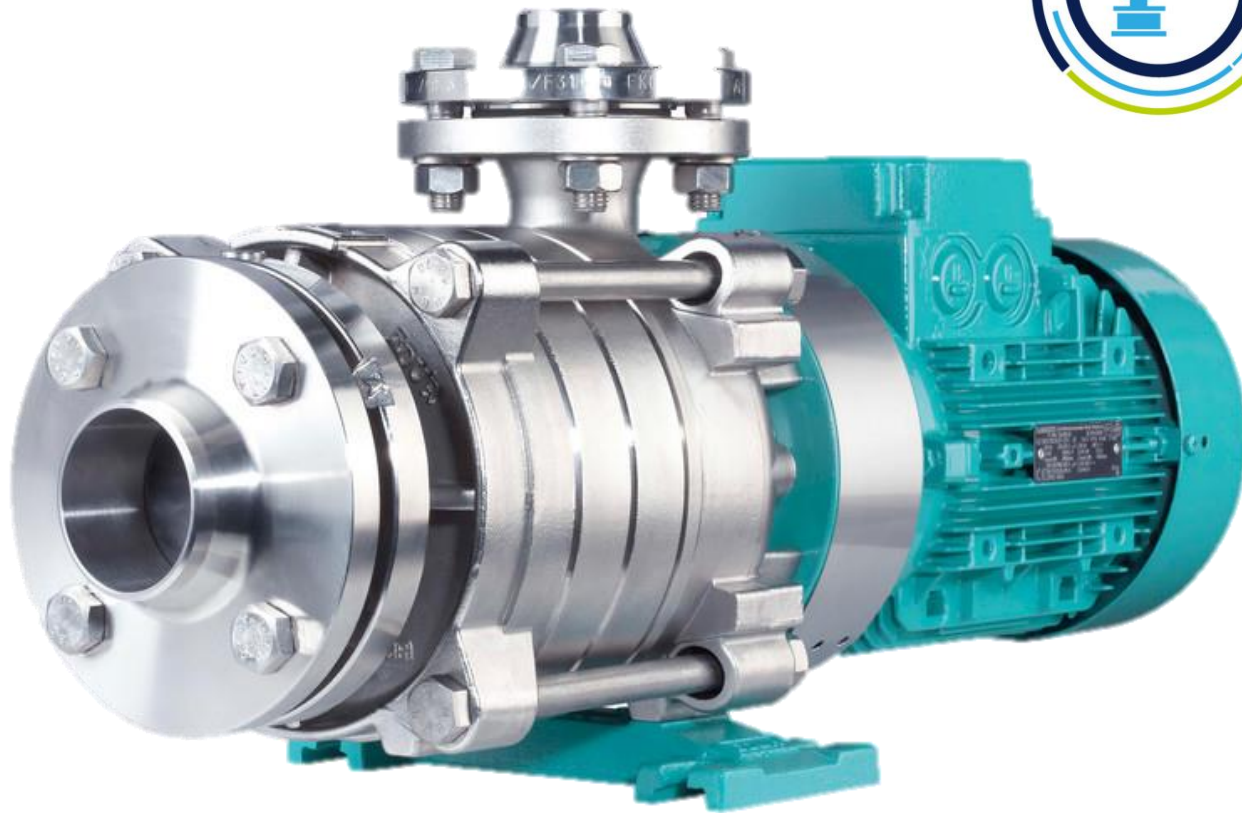


Analog & Power for Motor Control



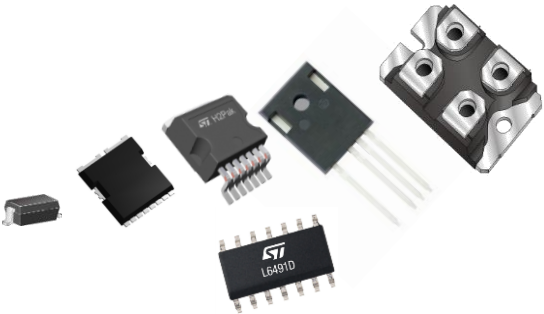
Marketing & Application EMEA



Analog and Power for **HIGH VOLTAGE MOTOR CONTROL**

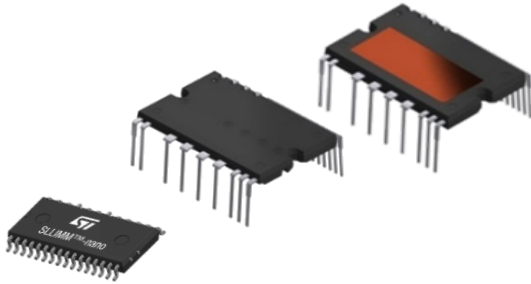
HV Motor Drives Top 3 Product Clusters

ACEPACK™ → Highest current density package in ST power portfolio



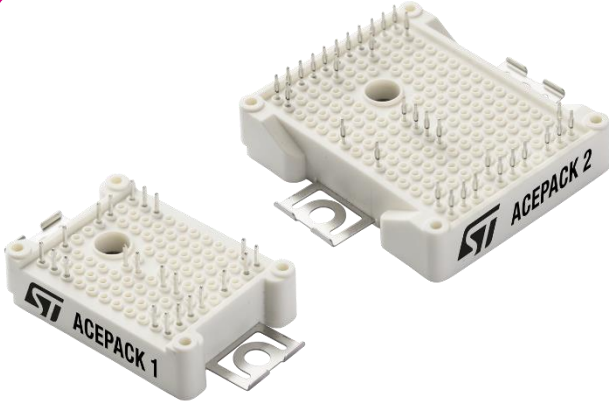
Discrete & Drivers & SIP

Typical Power: 10W ÷ 5kW



SLLIMM™ IPM

Typical Power: 20W ÷ 4kW



ACEPACK™ Power Modules

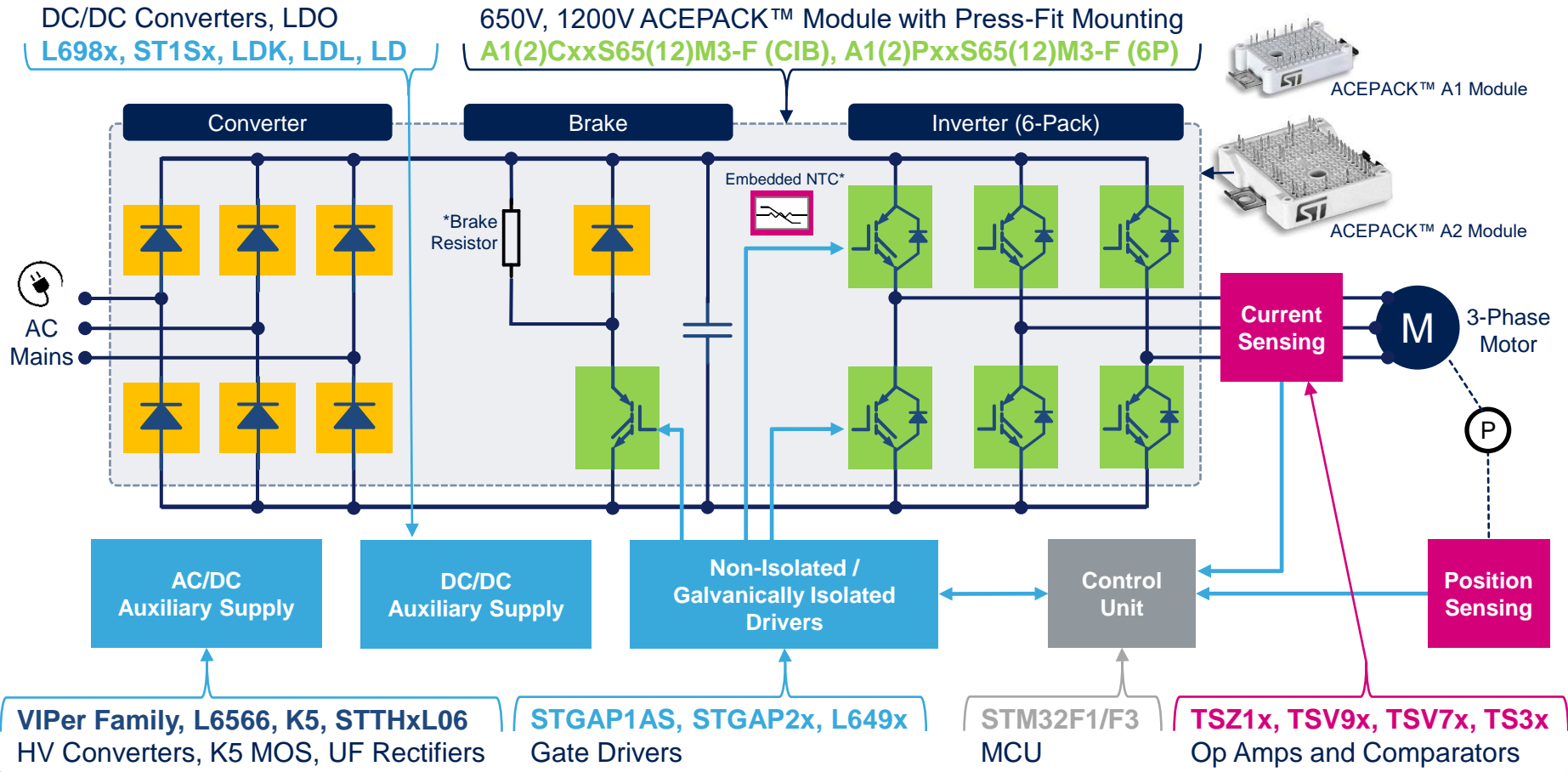
Typical Power: 3kW ÷ 30kW



High Voltage, High Power Motor Drive

Typical schematic & Product mapping

Converter Inverter Brake (CIB) or 6-Pack (6P) with ACEPACK™ Module for 3-Phase Motor

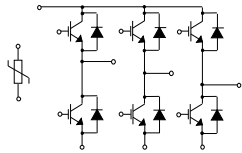


* Brake resistor and DC link capacitor are not part of ACEPACK™ Module

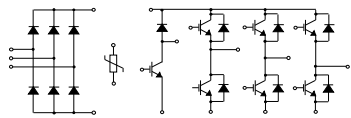


ACEPACK™ Module for Motor Control

Standard products available (Solder-Pin and Press-Fit Connection)



Six-Pack + NTC



CIB + NTC



ACEPACK™ 1

| Part Number* | Topology | BV _{CES} | I _C rating |
|---------------|--------------------------|-------------------|-----------------------|
| A1P25S12M3/-F | Six-Pack | 1200V | 25A |
| A1P35S12M3/-F | | | 35A |
| A1C15S12M3/-F | Converter Inverter Brake | 1200V | 15A |
| A1P50S65M2/-F | Six-Pack | 650V | 50A |



ACEPACK™ 2

| Part Number* | Topology | BV _{CES} | I _C rating |
|---------------|--------------------------|-------------------|-----------------------|
| A2C25S12M3/-F | Converter Inverter Brake | 1200V | 25A |
| A2C35S12M3/-F | | | 35A |
| A2P75S12M3/-F | Six-Pack | 1200V | 75A |
| A2C50S65M2/-F | Converter Inverter Brake | 650V | 50A |

*Connection Pins type:
-F = Press-Fit | if blank = Solder-Pin



Gate Drivers- Portfolio Overview

A future-proof portfolio for a wide range of applications

Electric/ Hybrid vehicles

1200 V inverters

Server, UPS

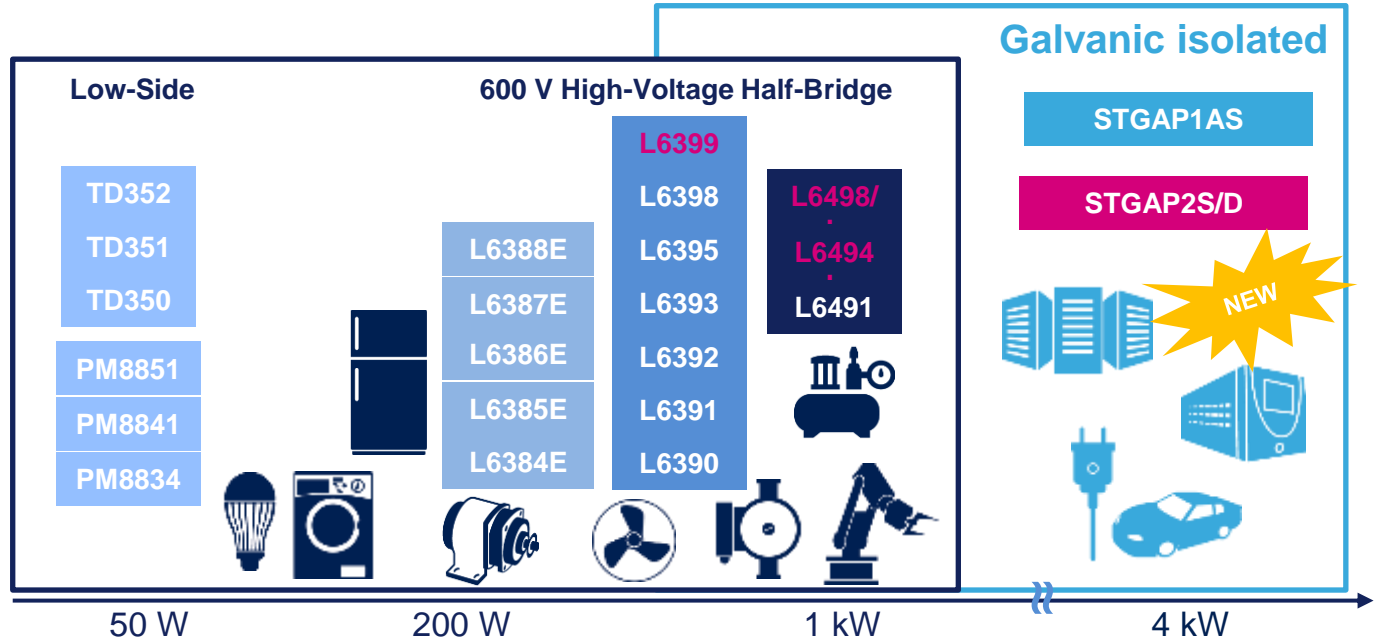
Compressors

Factory Automation

White goods

Solar

E-bikes



* New 2017



STGAP2S/ STGAP2D

8

1700 V, 4A Galvanically Isolated Drivers

Samples Available!

SOP in Q3 2018



KEY APPLICATIONS

- Motor driver
- Factory automation
- Industrial drives and Fans
- DC/DC converters
- Welding

Key benefits & features

High performance

- **Up to 1700 V high voltage rail**
- Best In Class for propagation delay **80ns**
- 4A sink / source driver current capability
- **± 100 V / ns transient immunity**
- 3.3 to 5 V TTL/CMOS inputs with hysteresis

Value for Customer

- Best in Class for fast speed
- Reduced BOM thanks to embedded Isolation and Miller Clamp feature

Minimum footprint and lightweight

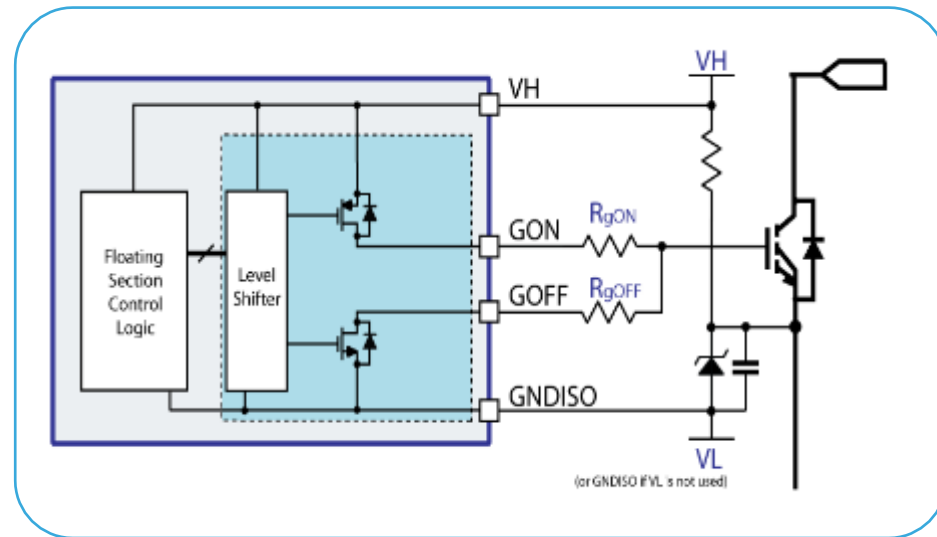
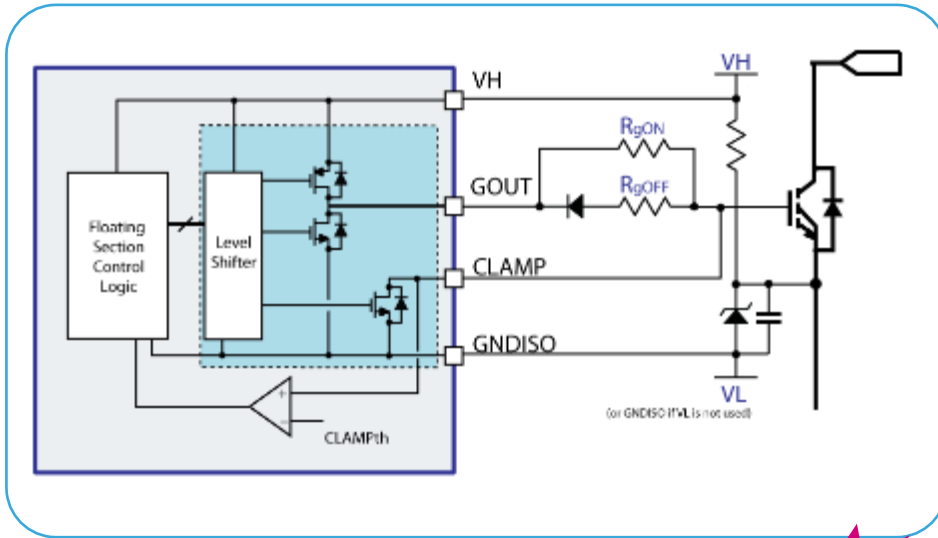
- Compact and simplified layout **SO8** package (STGAP2S)



1700 V, 4A Galvanically Isolated Drivers

Samples Available!

SOP in Q3 2018



STGAP2SCM:
Single output and Miller CLAMP

STGAP2SM:
Separated sink\source outputs



1700 V, 4A Galvanically Isolated Drivers

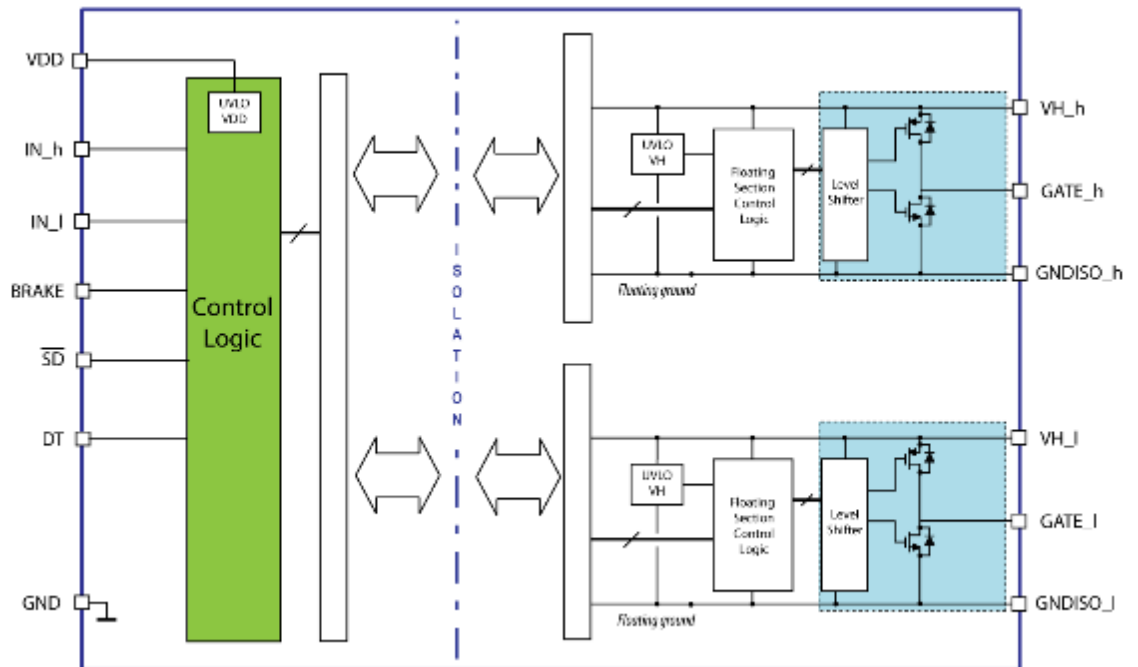
Samples Available!

SOP in Q3 2018

- 3V3 / 5 V logic inputs (1/3, 2/3 of VDD thresholds)
- **Up to 26 V supply voltage**
- **4 A Sink/Source current capability**
- Single input pin, in phase with output
- Shut-down SD pin, with integrated pull-down
- Propagation delay < 100 ns over temperature
- BRAKE pin
- UVLO Function (for each supply)
- Interlocking
- Programmable Dead-Time
- Stand-by function
- Temperature shut-down protection
- > 100 V/ns CMTI
- **Galvanic isolation**
 - **1.7 kV V_{IORM}**



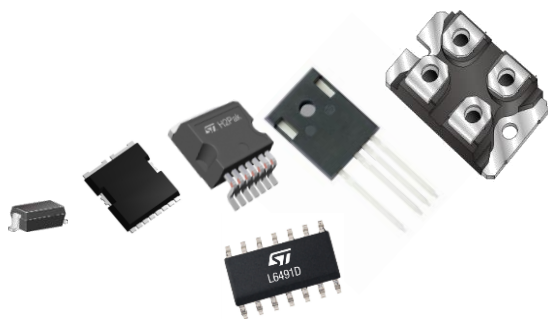
SO16N



HV Motor Drives Top 3 Product Clusters

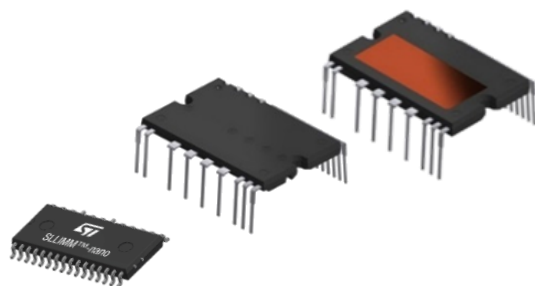
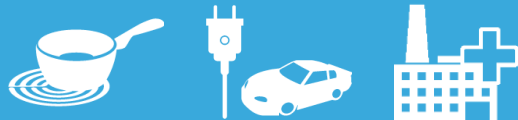
10

SLLIMM™ IPM



Discrete & Drivers & SIP

Typical Power: 10W ÷ 5kW



SLLIMM™ IPM

Typical Power: 20W ÷ 3kW



ACEPACK™ Power Modules

Typical Power: 3kW ÷ 30kW

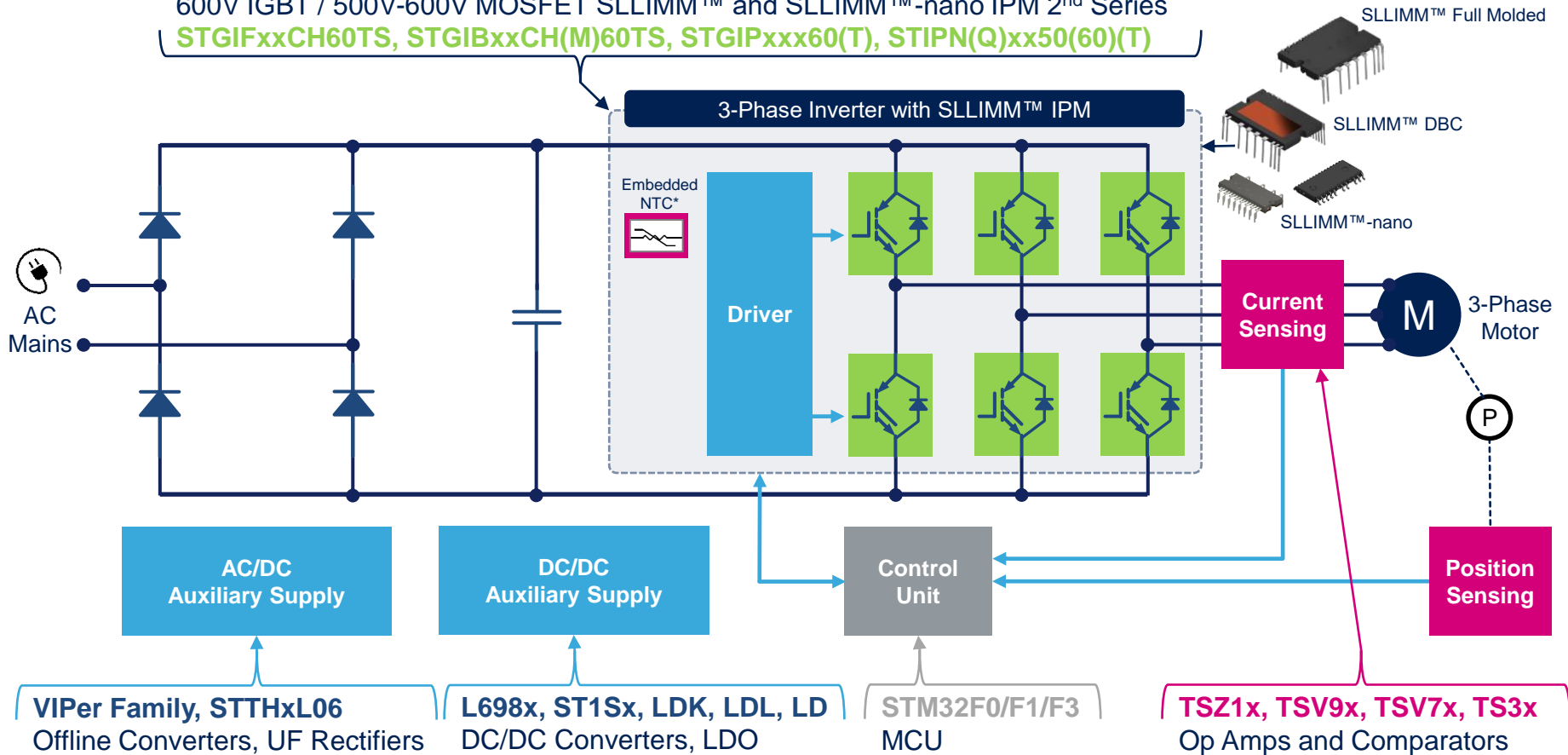


High Voltage, Low/Mid Power Motor Drive

Typical schematic & Product mapping

SLLIMM™ and SLLIMM™-nano IPM for 3-Phase Motor

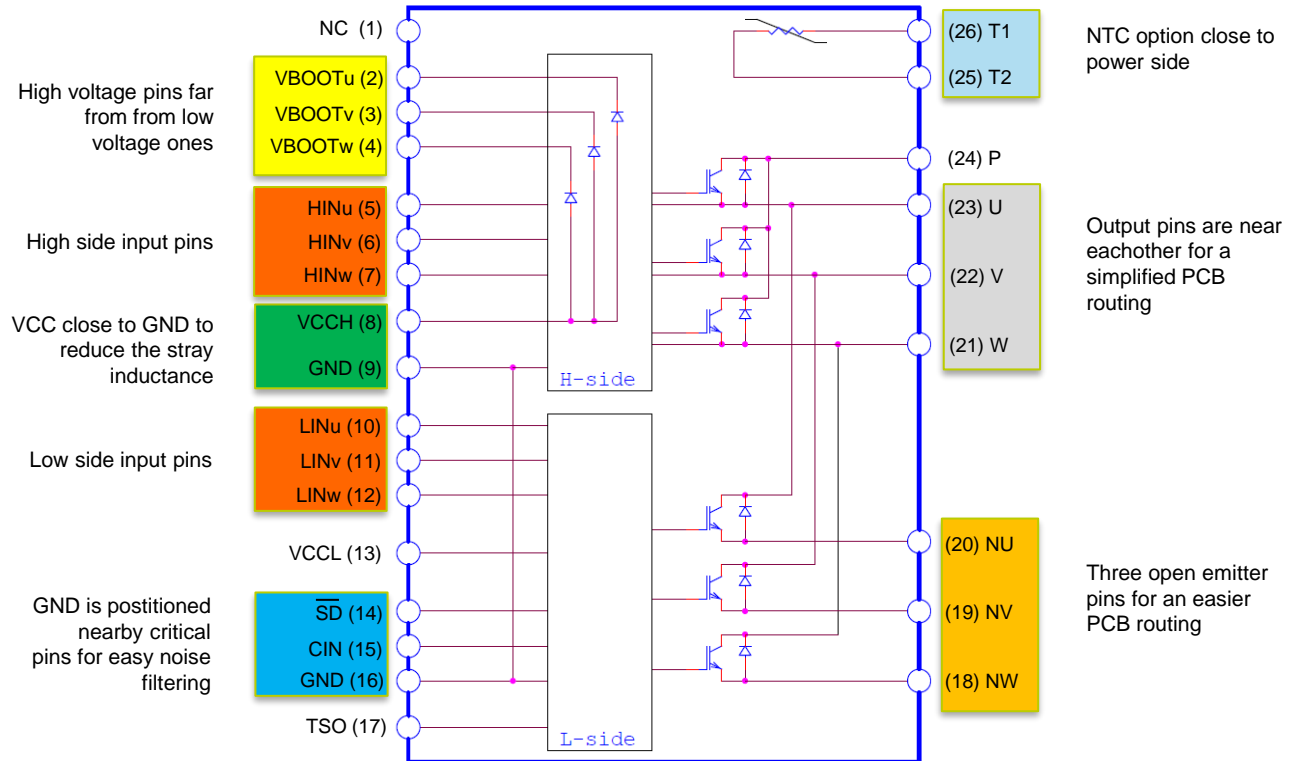
600V IGBT / 500V-600V MOSFET SLLIMM™ and SLLIMM™-nano IPM 2nd Series
STGIFxxCH60TS, STGIBxxCH(M)60TS, STGIPxxx60(T), STIPN(Q)xx50(60)(T)



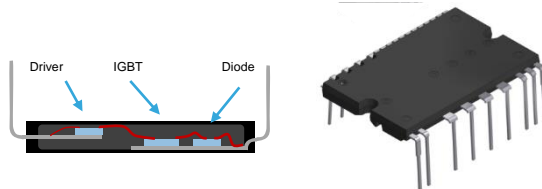
* NTC for temperature control is an option. "T" in the ordering code indicates that the NTC is present.



SLLIMM™ 2nd Series Technical Info

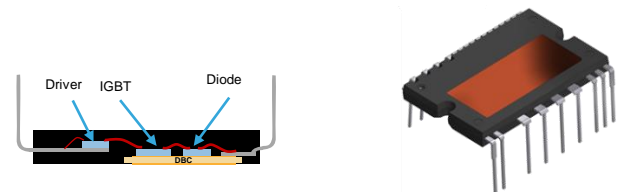


Full Molded



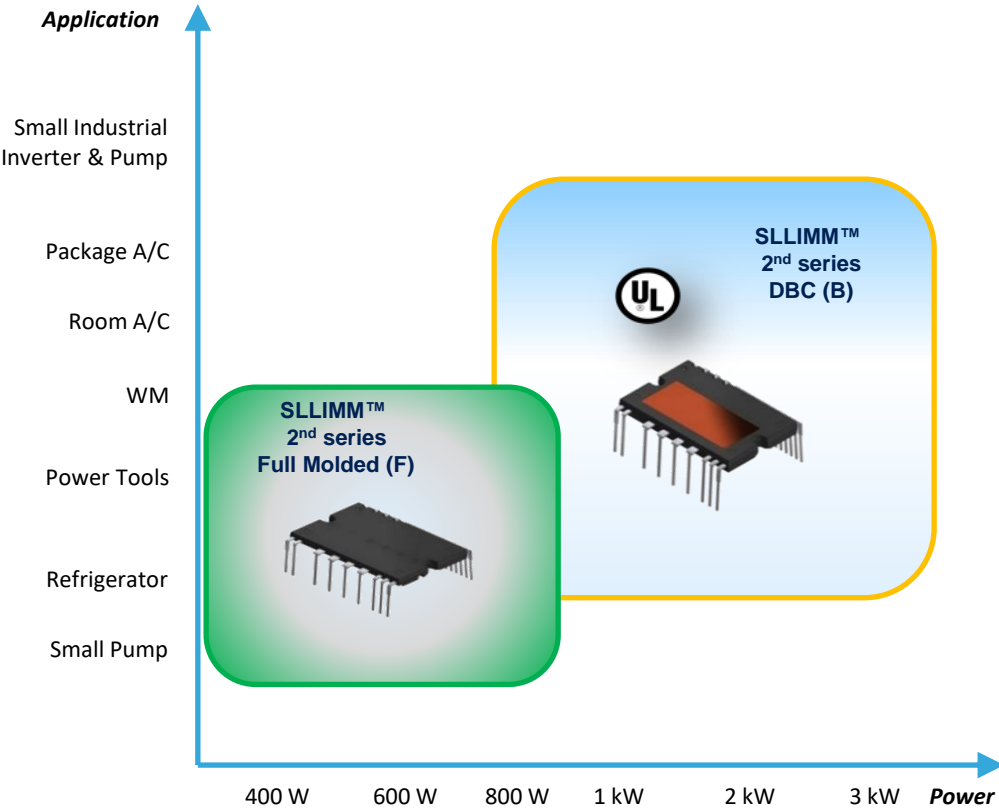
- Ideal choice for low/medium power platforms

Direct Bonded Copper (DBC)



- Improved DBC for power side for a better thermal dissipation
- Vacuum soldering process to improve the die attach

SLLIMM™ IPM 2nd Series Product Plan



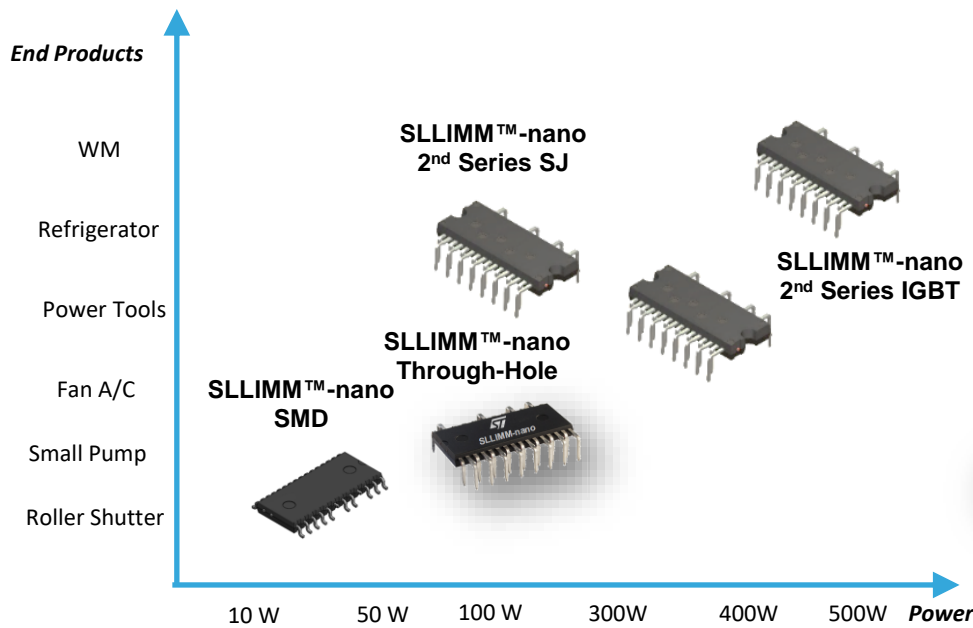
| SLLIMM 2 nd series Full Molded (F) | | BV | I _{CN} 25°C | MP |
|---|-----------------|------|----------------------|-----------|
| IGBT based | STGIF5CH60TS-L | 600V | 8A | Available |
| | STGIF7CH60TS-L | | 10A | Available |
| | STGIF10CH60TS-L | | 15A | Available |

| SLLIMM 2 nd series DBC (B) | | BV | I _{CN} 25°C | Max R _{DS(on)} | MP |
|---------------------------------------|-----------------|------|----------------------|-------------------------|-----------|
| IGBT based | STGIB8CH60TS-L | 600V | 12A | - | Available |
| | STGIB10CH60TS-L | | 15A | | Available |
| | STGIB15CH60TS-L | | 20A | | Available |
| | STGIB20M60TS-L | | 25A | | Available |
| | STGIB30M60TS-L | | 35A | | Available |
| SJ MOSFET based | STIB1060DM2T-L | 600V | 10A | 0.2Ω | Q4/18 |
| | STIB1560DM2T-L | | 15A | 0.15Ω | Q4/18 |

SLLIMM™
2nd series



SLLIMM™-nano IPM Product Plan

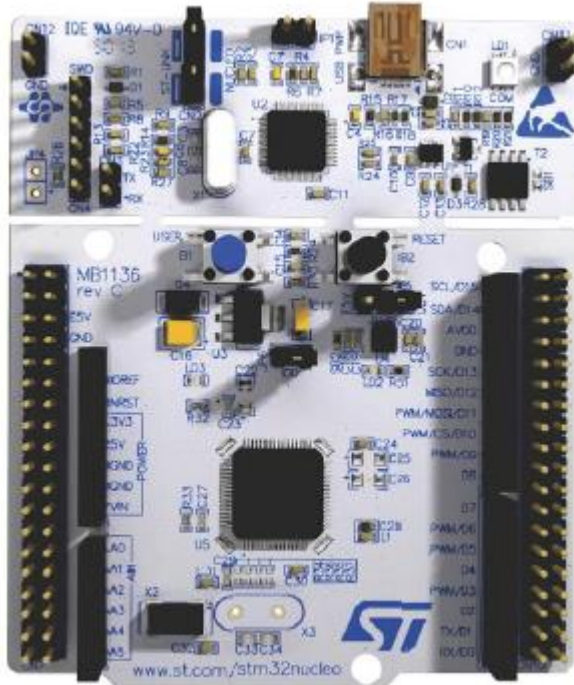


| SLLIMM™-nano SMD | | BV | I _{CN} 25°C | Max R _{DS(on)} | MP |
|------------------|-----------------|------|-------------------------|----------------------------|-----------|
| IGBT based | STGIPNS3H60T-H | 600V | 3A | - | Available |
| | STGIPNS3HD60-H | | | | Available |
| MOSFET based | STIPNS2M50(T)-H | 500V | 2A | 1.7Ω | Available |
| | STIPNS1M50T-H | | 1A | 3.6Ω | Available |
| | STIPNS1M50SDT-H | | | | Available |

| SLLIMM™-nano Through-Hole | | BV | I _{CN} 25°C | Max R _{DS(on)} | MP |
|---------------------------|----------------------|------|-------------------------|----------------------------|-----------|
| IGBT based | STGIPN3H60(A)(T)-(H) | 600V | 3A | - | Available |
| | STGIPN3HD60-H | | | | Available |
| MOSFET based | STIPN2M50(T)-H(L) | 500V | 2A | 1.7Ω | Available |
| | STIPN1M50(T)-H(L) | | 1A | 3.6Ω | Available |

| SLLIMM™-nano 2nd Series | | BV | I _{CN} 25°C | Max R _{DS(on)} | MP |
|-------------------------|---------------------|------|-------------------------|----------------------------|-----------|
| IGBT based | STGIPQ3H60T-HZ/L(S) | 600V | 3A | - | Available |
| | STGIPQ3HD60-HZ/L | | 3A | | Available |
| | STGIPQ5C60T-HZ/L(S) | | 5A | | Available |
| | STGIPQ8C60T-HZ | | 8A | | Available |
| SJ MOSFET based | STIPQ3M60T-HZ/L | 600V | 3A | 1.6Ω | Available |
| | STIPQ5M60T-HZ/L | | 5A | 1.0Ω | Available |

Evaluation boards, test your Motor with ST



+



+



STM32 NUCLEO Board

X-NUCLEO-IHM09M1 Exp.

STEVAL-IPMxxx Board

The easiest and fastest way to evaluate any SLLIMM™ IPM with your own 3-Phase Motor



ST PowerStudio

ST PowerStudio

Dynamic electro-thermal simulation software for power devices



Scope:

- Supports SLLIMM™ & ACEPACK™ families
- Enables DC/AC 3-phase 2-level application
- Compatible with Windows & MAC OS X*
- Freeware software

Comprehensive Analysis:

- Static and dynamic load mission profile
- Long mission profile duration of hours
- Several thermal setup
- Deep analysis of junction temperatures

High Connectivity:

- Multi language (English, Chinese*, Japanese*)
- Quick link to st.com doc (product page, DS)
- Output Report
- Online Forum

ST PowerStudio - The Dynamic Electro-Thermal Simulation Software for Power Devices by ST (ver: 1.0.0)

Product Selection

Application: DC-AC

Topology (mandatory field): 3-phase 2-level

Topology Design: [Circuit Diagram]

Product Information:

- Configuration: IGBT 3-phase 2-level
- Package: IGBT3-DC
- Package size (mm): 38 D24 D15
- Package technology: DBC substrate
- Leads option: long leads
- Voltage (V): 600
- Current (A) (Tj=25°C) (Tj=80°C): 15 (15)
- Temperature monitoring: NTC and TSD
- Integrated Bootstrap Diodes: YES
- Small Signal Function: YES
- SD (enable/func) Function: YES (OC, UVLO)
- Opening for Advanced Current Sensing: NO
- Comparator for Fault Protection: YES
- Input signal: Active High (HS)/Active High (LS)

Package: [Image of IGBT package]

Family: SLLIMM 2nd series

Device (I1) (mandatory field): STG10CH60TS-L

Mission Profile:

- Static Load
- Dynamic Load
- Fixed Thermal Setup (With Heatsink)
- Without Heatsink
- Fixed Heatsink Rth (°C/W): 2

Thermal Set-up:

- Heatsink Zth Parameters (s):

| | | | |
|----|---|----|-----|
| R1 | 2 | t1 | 100 |
| R2 | 0 | t2 | 0 |
| R3 | 0 | t3 | 0 |
| R4 | 0 | t4 | 0 |

Input Data:

| | | | |
|---|-------------|--------------|---------|
| Simulation time (s) | 0.001 + 15 | Steady State | No |
| I _{gh} : RMS Phase Current (A) | 0.01 + 15 | | 5.00 |
| P _{out} : Output Power (W) | 0.1 + 20000 | | 1081.87 |
| V _{dc} : DC Link Voltage (V) | 20 + 450 | | 300.00 |
| f _{sw} : Switching Frequency (kHz) | 1 + 40 | | 10 |
| f _{sin} : Output Frequency (Hz) | 0.1 + 500 | | 50.0 |
| PF: Power Factor | 0.1 + 1 | | 0.8 |
| MI: Modulation Index | 0.01 + 1 | | 0.85 |
| T _{amb} : Ambient Temperature (°C) | 25 + 100 | | 50 |
| T _{case} : Case Temperature (°C) | 25 + 125 | | 90.0 |

Output Data:

| | T1 | D1 |
|------------------------------|--------|-------|
| Conduction Loss (avg) (W) | 2.32 | 0.55 |
| Switching Loss (avg) (W) | 1.34 | 0.13 |
| Total Loss (avg) (W) | 3.66 | 0.69 |
| Junction Temp. (Max) (°C) | 102.55 | 93.15 |
| Junction Temp. (avg) (°C) | 97.75 | 91.77 |
| T1 = D1 Total Loss (avg) (W) | 4.35 | |
| System Total Loss (avg) (W) | 26.11 | |
| Case Temp. (Max)(°C) | 90.00 | |
| Heatsink+TIM Rth (°C/W) | 1.53 | |

Charts:

Graph 1: Junction Temperature vs. time

Graph 2: T1-D1 Power Loss vs. time

* Available in the next releases

STSW-POWERSTUDIO

Available now on st.com

www.st.com/en/embedded-software/stsw-powerstudio.html





Analog & Power for **LOW VOLTAGE MOTOR CONTROL**



STSPIN Innovation Update

Drive your low voltage motor with ease



STSPIN200

STSPIN800

STSPIN32

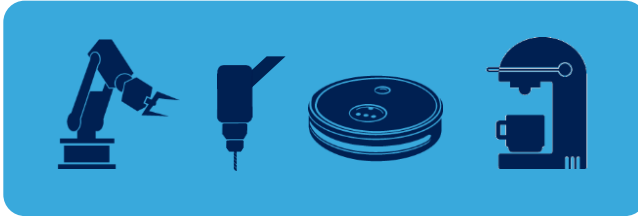
& F7 MOSFETs

1.8V to 10V | 1.3A/2.6A_{RMS}

7V to 45V | 1.5A/3A_{RMS}

6.6V to 45V

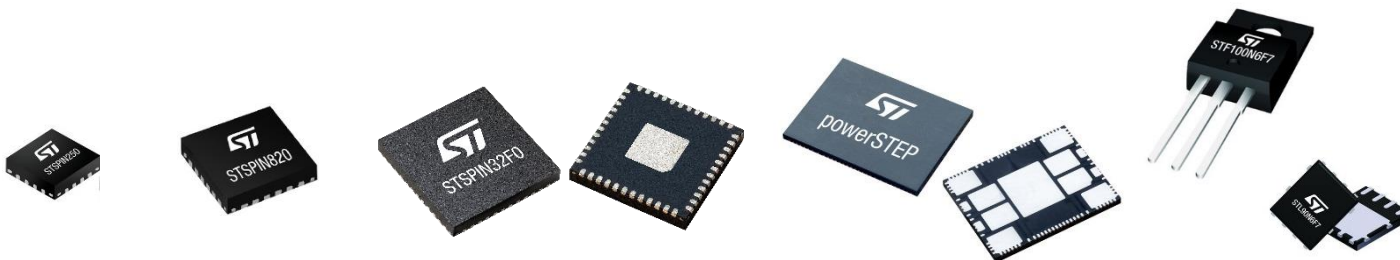
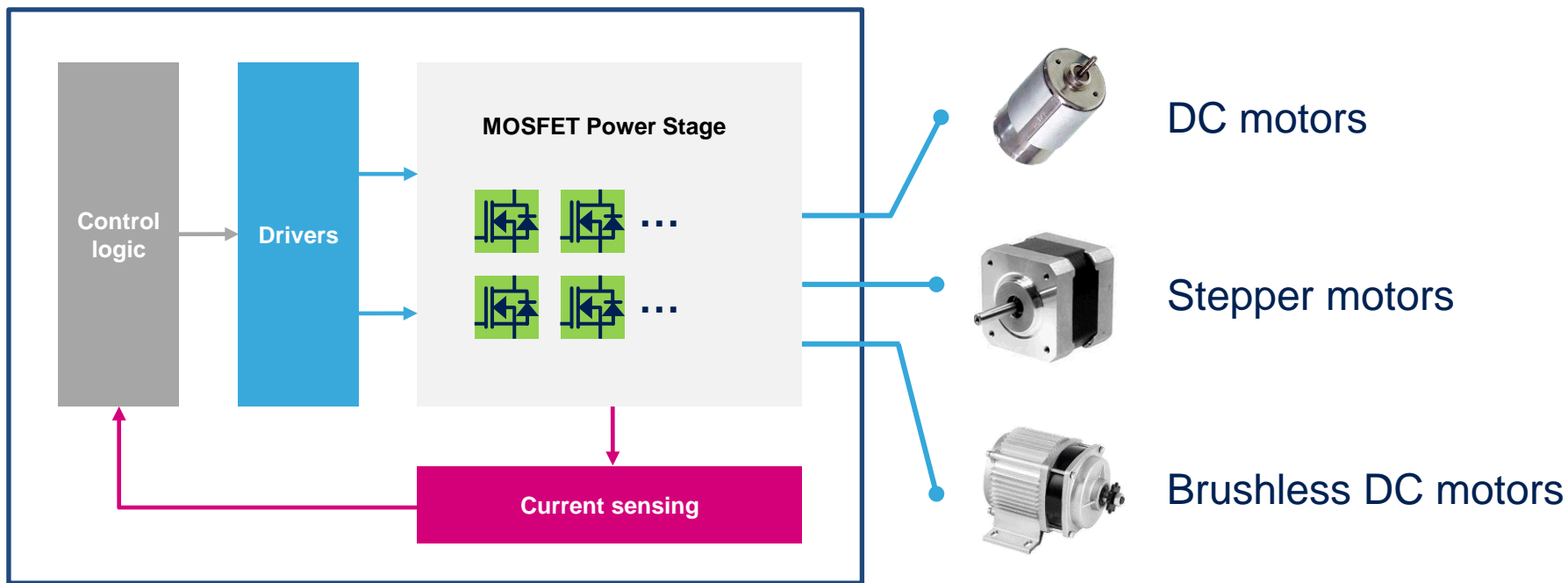
& 40V to 100V





Low Voltage Motor Control by means of ST

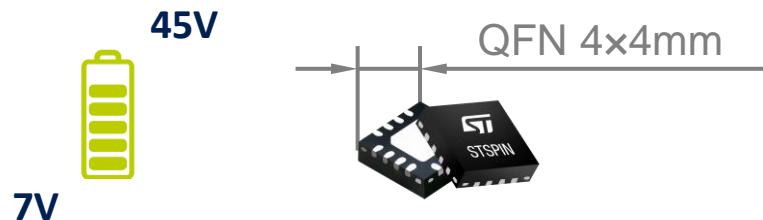
STSPIN™ & F7 MOSFET Technology





STSPIN Innovation Update

STSPIN800: Cutting-Edge Motion Control Technology



$$I = 1.5A_{RMS} \mid R_{DS(on)} = 500m\Omega$$

- Ultra-low standby consumption below 50µA
- 1/256 microstepping (STSPIN820)

- Integrated protection & diagnostics
- Miniaturized QFN 4x4 mm

Stepper



STSPIN820

BLDC



STSPIN830

Brushed DC

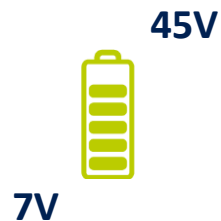
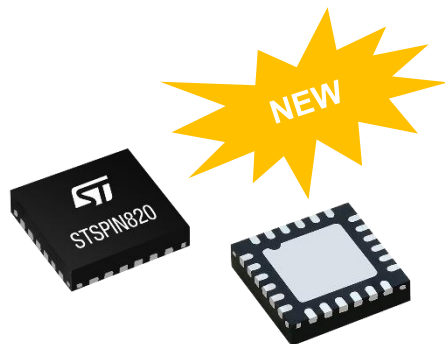


STSPIN840



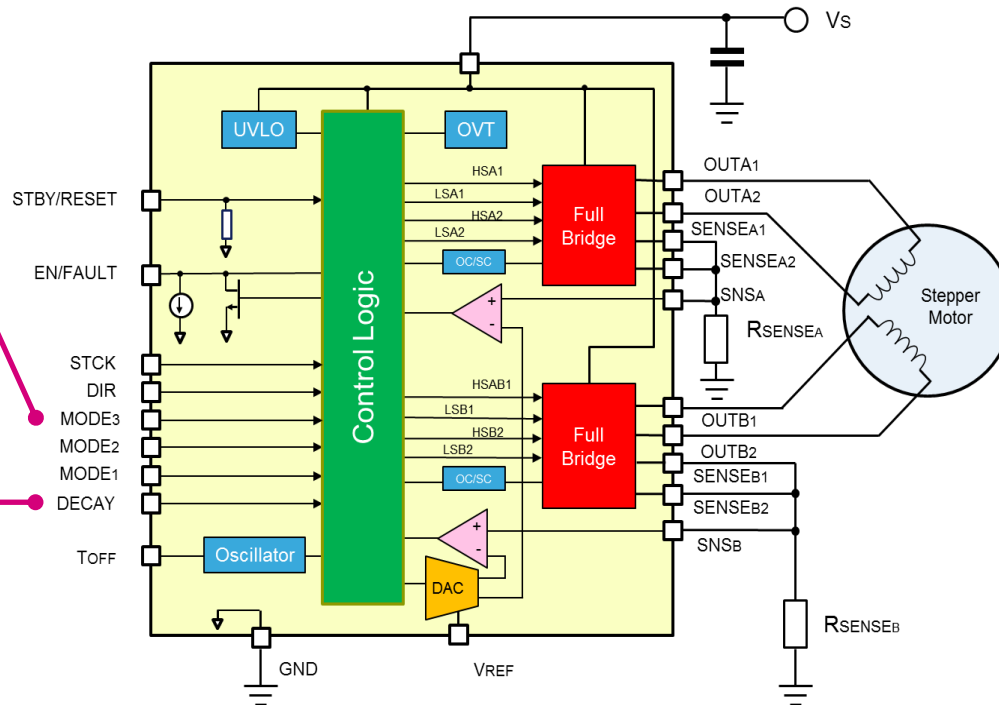
STSPIN Innovation Update

STSPIN820: Up to 1/256 microstepping on-the-fly!



On-the-fly microstepping configuration

Flexible decay selection





STSPIN Innovation Update

STSPIN830: Three-phase brushless DC motor driver



BLDC

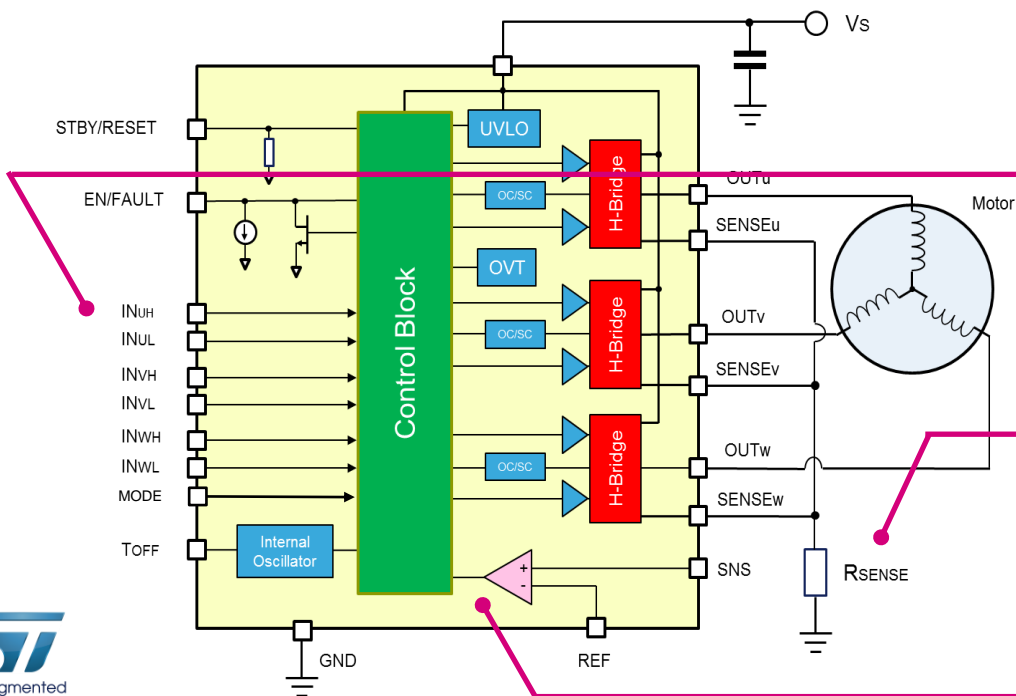


STSPIN830



7V

45V



3 & 6 INx compatible

Single-shunt/three-shunt
FOC ready

Embedded current limiter



STSPIN Innovation Update

STSPIN840: Single/dual brushed DC motor driver



Brushed DC

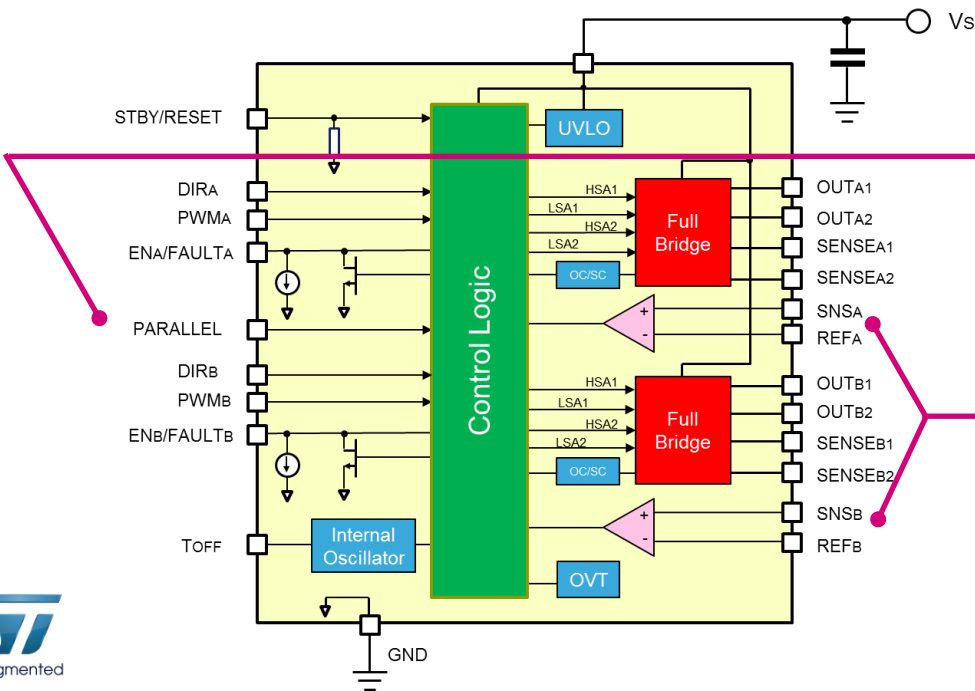


STSPIN840



7V

45V



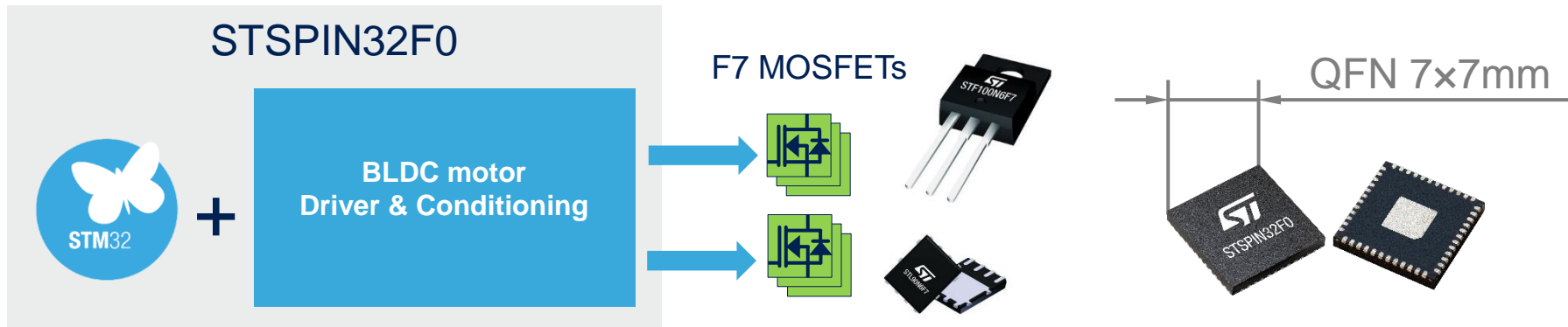
Optimized parallel bridge control

More flexibility with dual current control loop



STSPIN32F0 For Motor Control

Motor Driver IC integrating an advanced BLDC controller and a 32-bit MCU

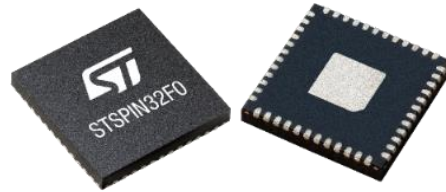


High integration with embedded 32-bit STM32F0 MCU with ARM® Cortex®-M0

High performance 3-phase gate driver up to 600 mA and 45 V

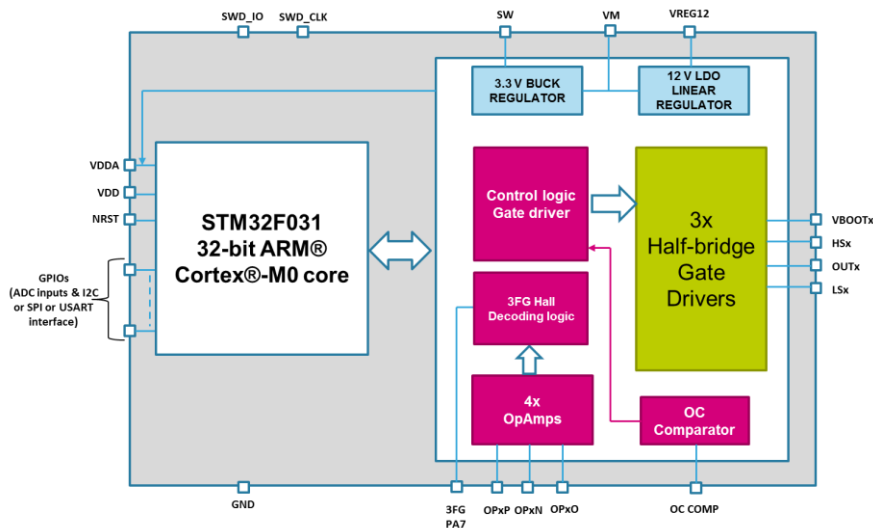
Cost-effective sensorless or hall-effect sensors controls

Compact design in a 7x7 mm QFN package



STSPIN32F0

Advanced 3-phase BLDC driver + STM32



KEY APPLICATIONS:

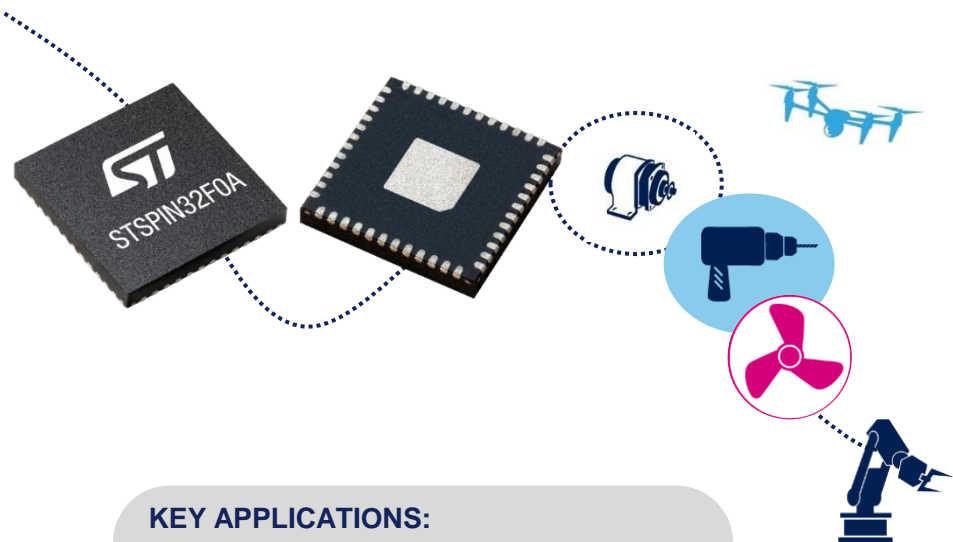
- **Industrial automation**
- **Robotics**
- **Fans**
- **Battery powered Home Appliances**
- Drones and aeromodelling
- Power tools

Key Features

- **STM32 Cortex™ M0 + 3-phase Gate Driver**
- **Fully compatible with STM32 ecosystem**
- **12V LDO & 3.3V DC-DC regulators integrated**
- **FOC & 6-step sensorless / sensed algorithms**
- VS = 45 V, I = 600mA driving capability
- 48 MHz, 32k Flash & 4k SRAM
- 12 bit ADC
- I2C / UART / SPI
- Fully protected (UVLO, Short-circuit, OCP, OTP)
- 4 Op-Amps & 1 Comparator
- Compact design with 7x7 mm QFN
- Extended temp range: -40 to 125°C



Advanced 3-phase BLDC driver + STM32 – from 2 Li-Po Cells to 45V



KEY APPLICATIONS:

- Power tools
- Fans
- Drones and aeromodelling
- Battery powered Home Appliances
- Industrial automation
- Robotics

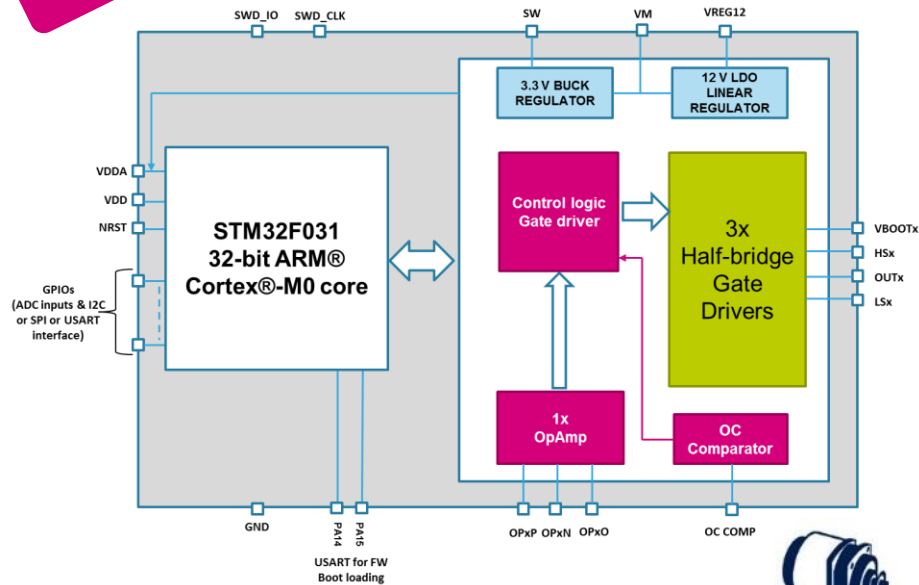
Key Features

- **STM32 Cortex™ M0 + 3-phase Gate Driver**
- **Fully compatible with STM32 ecosystem**
- **12V LDO & 3.3V DC-DC regulators integrated**
- **6step & FOC sensorless / sensed algorithms**

- VS = **6.6V–45V**, I = 600mA driving capability
- 48 MHz, 32k Flash & 4k SRAM
- 12 bit ADC
- I2C / UART / SPI
- **FW boot loader support**
- Fully protected (UVLO, Short-circuit, OCP, OTP)
- **3 Op-Amps & 1 Comparator**
- Compact design with 7x7 mm QFN
- Extended temp range: -40 to 125°C

Available in Q3

Advanced 3-phase BLDC driver + STM32 – More GPIOs



Key Features

- **STM32 Cortex™ M0 + 3-phase Gate Driver**
- **Fully compatible with STM32 ecosystem**
- **12V LDO & 3.3V DC-DC regulators integrated**
- **6step control algorithm**
- **VS = 6.6V–45V, I = 600mA driving capability**
- **48 MHz, 32k Flash & 4k SRAM**
- **12 bit ADC**
- **I2C / UART / SPI**
- **20GPIOs & FW boot loader support**
- **Fully protected (UVLO, Short-circuit, OCP, OTP)**
- **1 Op-Amp & 1 Comparator**
- **Compact design with 7x7 mm QFN**
- **Extended temp range: -40 to 125°C**

KEY APPLICATIONS:

- **Power tools**
- **Fans**
- **Battery powered Home Appliances**
- **Industrial automation**





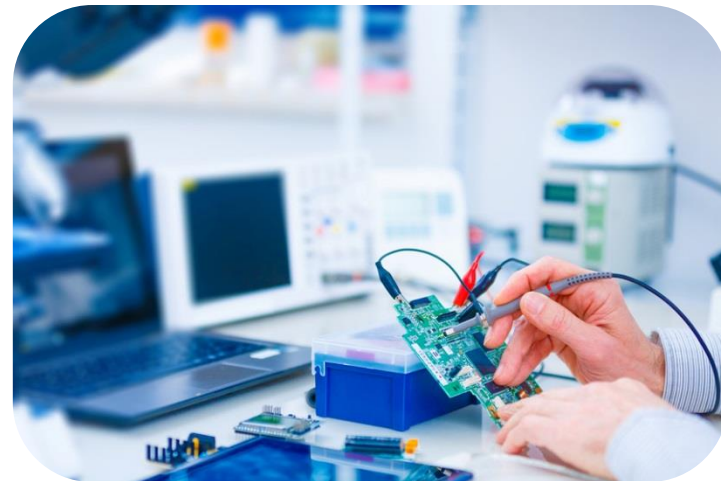
STSPIN32F0/A/B Easy Comparison

| Feature | STSPIN32F0 | STSPIN32F0A | STSPIN32F0B |
|--------------------------------|--------------------------------------|--------------------------------------|--------------------------------------|
| Operating voltage | 7.9 V to 45 V | 6.6 to 45 V | 6.6 to 45 V |
| Embedded MCU | STM32F031x6 with extended temp range | STM32F031x6 with extended temp range | STM32F031x6 with extended temp range |
| Gate drivers | 600 mA triple half-bridge | 600 mA triple half-bridge | 600 mA triple half-bridge |
| 3.3 V DC/DC buck conv | Embedded | Embedded | Embedded |
| 12 V LDO | Embedded | Embedded | Embedded |
| OpAmps | 4 | 3 | 1 |
| 3FG decoding logic | Embedded | Not embedded | Not embedded |
| Comparator | Embedded | Embedded | Embedded |
| # of GPIOs | 15 | 16 | 20 |
| OC protection via comparator | Available | Available | Available |
| Current control via comparator | Not available | Available | Available |
| Standby | Available | Available | Available |
| UVLO | Available | Available | Available |
| Firmware upgrade on the field | Not available | Available | Available |



STSPIN Evaluation Ecosystem

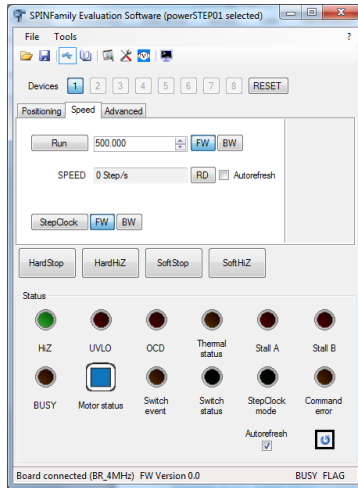
Speed-up your design with STSPIN!



Save Time with STSPIN Evaluation Ecosystem!

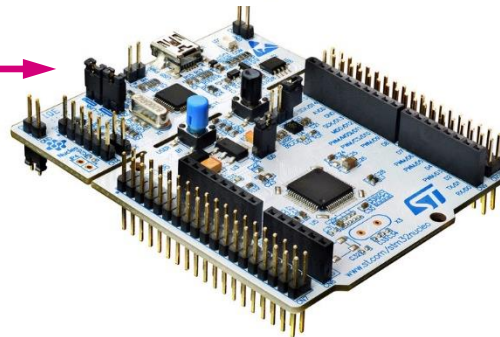
- ST provides a rich set of tools for easy evaluation and rapid app design with STSPIN!
- STSPIN evaluation ecosystem includes evaluation boards (X-NUCLEO) and free evaluation software (GUI) & STM32 firmware libraries (X-CUBE).

SPIN Family Evaluation Software



X-CUBE firmware package

X-NUCLEO-IHM03A1



NUCLEO-F401RE, NUCLEO-F030R8, NUCLEO-L053R8



24VDC Power Supply



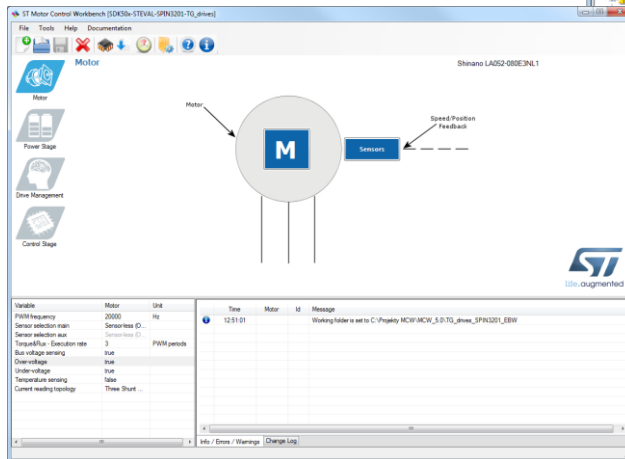
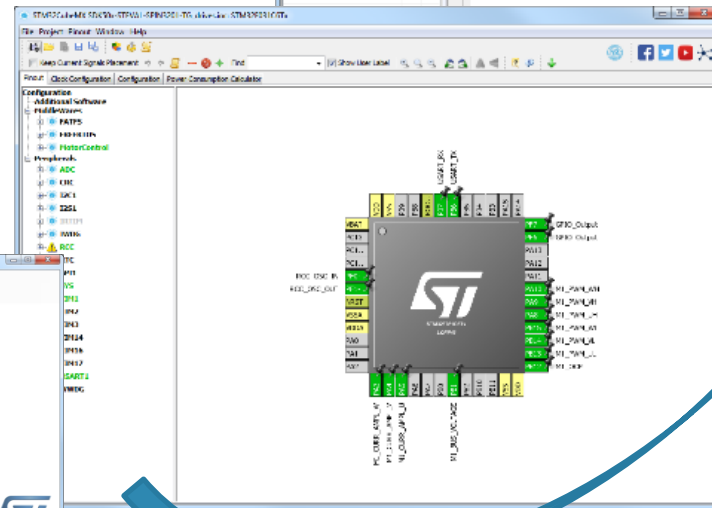
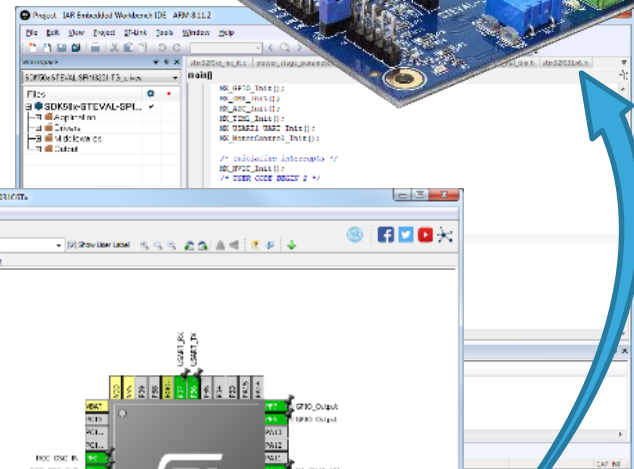
Stepper motor

Available
now

Motor Control Workbench 5

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- Easier to use than previous 4.3 versions
- Based on HAL libraries
- STM32CubeMX project generated from MC Workbench for quick and easy modification of peripheral settings





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